

MH188 Hall-effect sensor is a temperature stable, stress-resistant sensor. Superior high-temperature performance is made possible through a dynamic offset cancellation that utilizes chopper-stabilization. This method reduces the offset voltage normally caused by device over molding, temperature dependencies, and thermal stress.

MH188 includes the following on a single silicon chip: voltage regulator, Hall voltage generator, small-signal amplifier, chopper stabilization, Schmitt trigger, Advanced DMOS wafer fabrication processing is used to take advantage of low-voltage requirements, component matching, very low input-offset errors, and small component geometries.

This device requires the presence of both south and north polarity magnetic fields for operation. In the presence of a south polarity field of sufficient strength, the device output sensor on, and only switches off when a north polarity field of sufficient strength is present.

MH188 is rated for operation between the ambient temperatures -40°C and 85°C for the E temperature range, and -40°C to 125°C for the K temperature range. The two package styles available provide magnetically optimized solutions for most applications. Package SO is a SOT-23, a miniature low-profile surface-mount package, while package UA is a three-lead ultra mini SIP for through-hole mounting.

Packages is Halogen Free standard and which have been verified by third party lab.

Features and Benefits

- DMOS Hall IC Technology.
- Reverse bias protection on power supply pin.
- Chopper stabilized amplifier stage.
- Optimized for BLDC motor applications.
- Reliable and low shifting on high Temp condition.
- Switching offset compensation at typically 69 kHz.
- Good ESD Protection.
- 100% tested at 125 °C for K.
- Custom sensitivity / Temperature selection are available.
- RoHS compliant 2011/65/EU and Halogen Free

Applications

- High temperature Fan motor
- 3 phase BLDC motor application
- Speed sensing
- Position sensing
- Current sensing
- Revolution counting
- Solid-State Switch
- Linear Position Detection
- Angular Position Detection
- Proximity Detection
- High ESD Capability

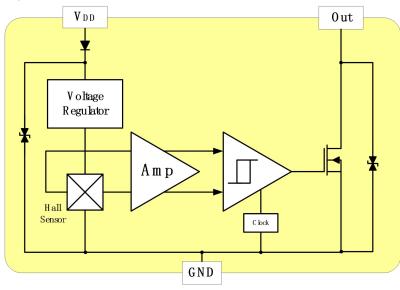


Ordering Information X-XXXX **Company Name and Product Category** MH:MST Hall Effect/MP:MST Power IC Part number Sorting Code 181,182,183,184,185,248,249,276,477,381,381F,381R,382..... If part # is just 3 digits, the forth digit will be omitted. Package type **Temperature range Temperature** Code E: 85 °C, I: 105 °C, K: 125 °C, L: 150 °C Package type Part number UA:TO-92S,VK:TO-92S(4pin),VF:TO-92S(5pin),SO:SOT-23, Company Name and product Category SQ:QFN-3,ST:TSOT-23,SN:SOT-553,SF:SOT-89(5pin), SS:TSOT-26,SD:DFN-6 Sorting α,β,Blank.....

| Part No. | Temperature Suffix | Package Type |
|----------|--|--------------------|
| MH188KUA | K (-40° C to + 125°C) | UA (TO-92S) |
| MH188KSO | K (-40°C to $+ 125$ °C) | SO (SOT-23) |
| MH188EUA | E (-40°C to $+ 85$ °C) | UA (TO-92S) |
| MH188ESO | E (-40°C to $+ 85$ °C) | SO (SOT-23) |
| MH188ESD | $E(-40^{\circ}C \text{ to } +85^{\circ}C)$ | SD (DFN2*2-6L) |
| MH188KSM | K(-40°C to +125°C) | SM (DFN1.6*1.6-6L) |

KUA spec is using in industrial and automotive application. Special Hot Testing is utilized.

Functional Diagram





MH188 Specifications Ultra High Sensitivity Hall Effect Latch

Absolute Maximum Ratings At (Ta=25°C)

| Characteristics | | Values | Unit | |
|--|------------------|-----------------|-----------------|------|
| Supply voltage, (VDD) | | 28 | V | |
| Output Voltage,(Vout) | | 28 | V | |
| Reverse voltage, (V _{DD}) | | -28/-0.3 | V | |
| Output current, (<i>lout</i>) | | 50 | mA | |
| Operating Temperature Range, (Ta) | | "E" version | -40 to +85 | °C |
| | | "K" version | -40 to +125 | °C |
| Storage temperature range, (<i>Ts</i>) | | -65 to +150 | °C | |
| Maximum Junction Temp,(<i>Tj</i>) | | 150 | °C | |
| | $(heta_{ja})$ U | A/SO/SD/SM | 206/543/160/250 | °C/W |
| Thermal Resistance | $(heta_{jc})$ U | A/SO/SD/SM | 148/410/35/50 | °C/W |
| Package Power Dissipation, (P_D) UA/SO/SD/SM | | 606/230/780/500 | mW | |

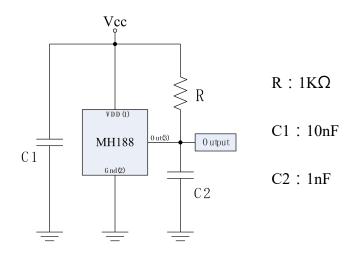
Note: Do not apply reverse voltage to V_{DD} and V_{OUT} Pin, It may be caused for Miss function or damaged device.

Electrical Specifications DC Operating Parameters $T_{4}=+25$ °C $V_{DD}=12V$

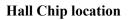
| Parameters | Test Conditions | Min | Тур | Max | Units |
|--|--|--------|------|--------|-------|
| Supply Voltage, (V _{DD}) | Operating | 2.5 | | 26.0 | V |
| Supply Current, (<i>I</i> _{DD}) | B <bop< td=""><td></td><td></td><td>5.0</td><td>mA</td></bop<> | | | 5.0 | mA |
| Output Saturation Voltage, (Vsat) | Iout=20mA,B>B _{OP} | | | 400.0 | mV |
| Output Leakage Current, (Ioff) | $I_{OFF} B < B_{RP}, V_{OUT} = 12V$ | | | 10.0 | uA |
| Power-On Time, (T_{PO}) | Power-On | | 0.05 | 0.10 | uS |
| Output Response Time, (<i>T_{RES}</i>) | Operating | | 0.30 | 0.65 | mS |
| Output Switch Frequency, (F_{SW}) | Operating | 3 | | | kHz |
| Output Rise Time, (T_R) | RL=1KΩ, CL =20pF | | 0.12 | 0.35 | uS |
| Output Fall Time, (<i>T_F</i>) | RL=1KΩ; CL =20pF | | 0.05 | 0.15 | uS |
| Electro-Static Discharge | HBM | 4 | | | KV |
| Operate Point, (B _{OP}) | UA/SD/SM (SO) | 5(-25) | | 25(-5) | Gauss |
| Release Point, (B_{RP}) | UA/SD/SM (SO) | -25(5) | | -5(25) | Gauss |
| Hysteresis, (B _{HYS}) | | | 30 | | Gauss |

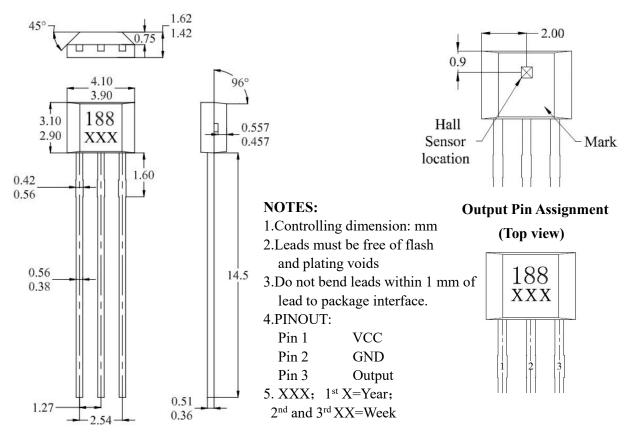


Typical application circuit



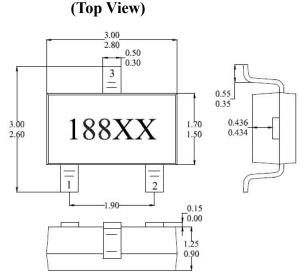
Sensor Location, Package Dimension and Marking UA Package







Package (SOT-23)

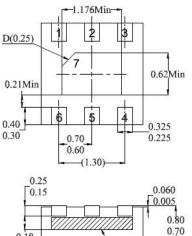


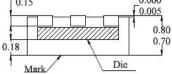
NOTES:

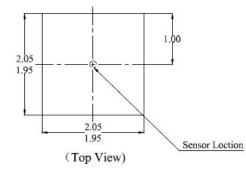
- 1. PINOUT (See Top View at left :) Pin 1 :V_{DD;} Pin 2: Output ; Pin 3 GND
- 2. Controlling dimension: mm
- 3. Lead thickness after solder plating will be 0.254mm maximum
- 4. XX: Date Code, Refer to DC table

SD Package

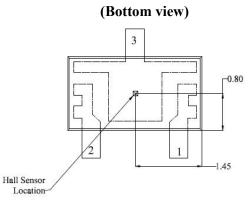




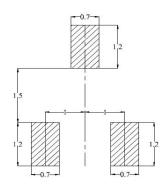




Hall Plate Chip Location



(For reference only) Land Pattern

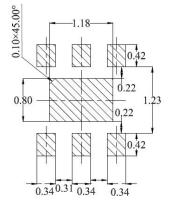


NOTES:

- 1. Controlling dimension: mm
- 2. Leads must be free of flash and plating voids
- 3. Lead thickness after solder plating will be 0.254mm maximum
- 4. PINOUT:

| Pin No. | Pin Name | Function |
|---------|----------|--------------|
| 1 | Vdd | Power Supply |
| 2 | N.C | N.C |
| 3 | Vout | Output |
| 4 | N.C | N.C |
| 5 | Vss | Ground |
| 6 | N.C | N.C |
| 7 | N.C | N.C |

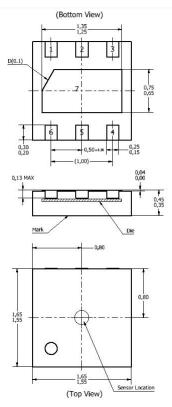
5. (For reference only) Land pattern





MH188 Specifications Ultra High Sensitivity Hall Effect Latch

<u>SM Package</u>



NOTES:

- 1. Controlling dimension: mm
- 2. Leads must be free of flash and plating voids
- 3. Lead thickness after solder plating will be 0.254mm maximum
- 4. Marking:A3X; X: Date Code, Refer to DC table
- 5. PINOUT:

| 1110011 | | |
|---------|-----------------|--------------|
| Pin No. | Pin Name | Function |
| 1 | V _{DD} | Power Supply |
| 2 | NC | NC |
| 3 | OUT | Output |
| 4 | NC | NC |
| 5 | V _{ss} | Ground |
| 6 | NC | NC |
| 7 | PAD | NC |

6. (For reference only) Land Pattern

